

D 5

D 6

D 7

D 8

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

MLP 3.3x3.3

Pin 1

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			150	V
V _{GS}	Gate to Source Voltage			±20	V
	Drain Current -Continuous (Package limited) T _C = 25 °C			16	
	-Continuous (Silicon limited) T _C = 25 °C			19	
D	-Continuous	T _A = 25 °C	(Note 1a)	4.6	Α
	-Pulsed			20	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	34	mJ
P _D	Power Dissipation	T _C = 25 °C		40	W
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C
Thermal Ch	naracteristics				
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$R_{ ext{ heta}JC}$	P _{0JC} Thermal Resistance, Junction to Case		°C / M	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a	53	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86240	FDMC86240	Power 33	13 "	12 mm	3000 units

4 | G

3 S

2 S

1 S

FDMC86240
N-Channel P
ower Trench [®]
MOSFET

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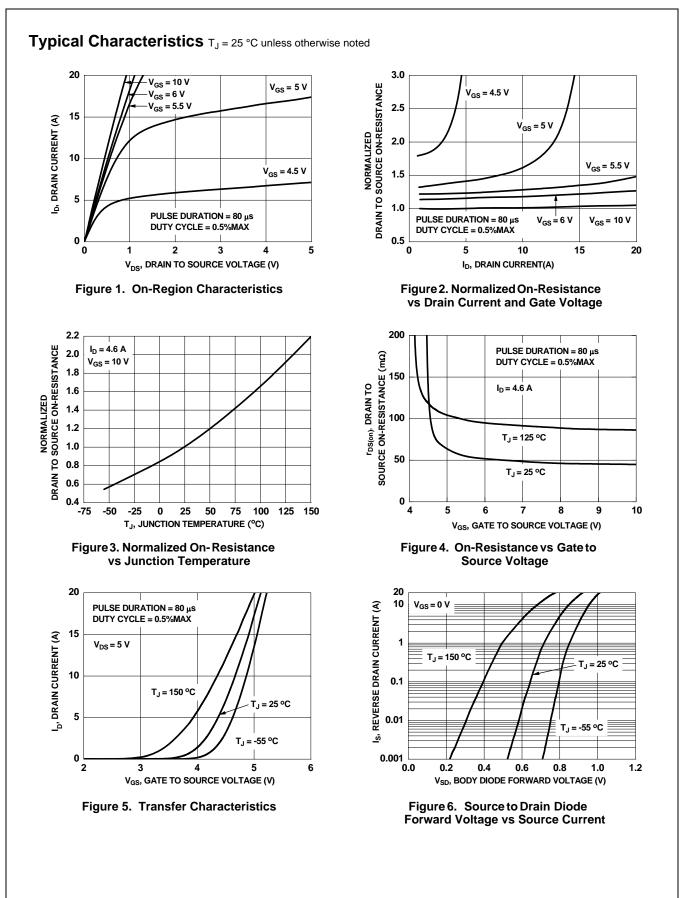
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		101		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	2.9	4.0	V
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-9		mV/°C
-		V _{GS} = 10 V, I _D = 4.6 A		44.7	51	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 6 \text{ V}, \ \text{I}_{D} = 3.9 \text{ A}$		51.4	70	mΩ
		$V_{GS} = 10 \text{ V}, \ I_D = 4.6 \text{ A}, \ T_J = 125 \text{ C}$	S°C	84.5	97	
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \ I_D = 4.6 \text{ A}$		15		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			680	905	pF
C _{oss}	Output Capacitance	$V_{DS} = 75 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		79	105	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		4.3	10	pF
R _g	Gate Resistance			0.5		Ω
Switching t _{d(on)}	Characteristics			8.2	17	ns
t _r	Rise Time	V_{DD} = 75 V, I _D = 4.6 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		1.7	10	ns
t _{d(off)}	Turn-Off Delay Time			14	26	ns
t _f	Fall Time			3.1	10	ns
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$ $V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V,$ $I_{D} = 4.6 A$		11	15	nC
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V$,		6	9	nC
Q _{gs}	Total Gate Charge	$I_{\rm D} = 4.6 {\rm A}$		2.8		nC
Q _{gd}	Gate to Drain "Miller" Charge	_		2.3		nC
	urce Diode Characteristics			1	I	1
		$V_{GS} = 0 V, I_S = 4.6 A$ (Note	e 2)	0.79	1.3	
V _{SD}	Source to Urain Diode Forward Voltade	$V_{GS} = 0 V, I_S = 2 A$ (Note	e 2)	0.75	1.2	V
t _{rr}	Reverse Recovery Time	$I_F = 4.6 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$		58	93	ns
Q _{rr}	Reverse Recovery Charge			63	102	nC
NOTES: 1. R _{θJA} is determ the user's boa	ined with the device mounted on a 1 in ² pad 2 oz copper pa rd design.	ad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta J}$	_C is guaranteed b	y design whil	e R _{θCA} is de	termined b
	53 °C/W when mou 1 in ² pad of 2 oz co			when moun n pad of 2 oz (

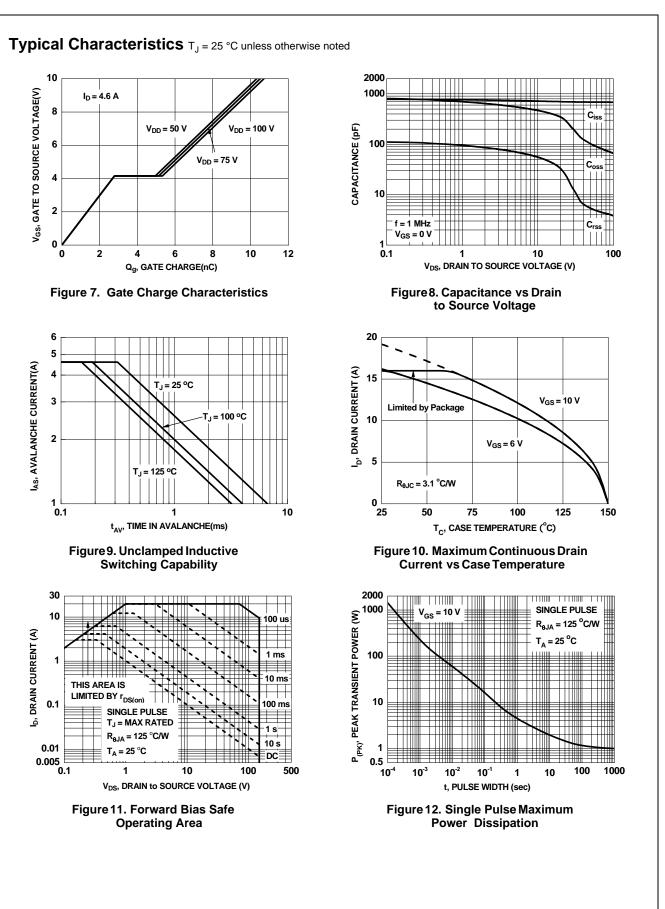
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

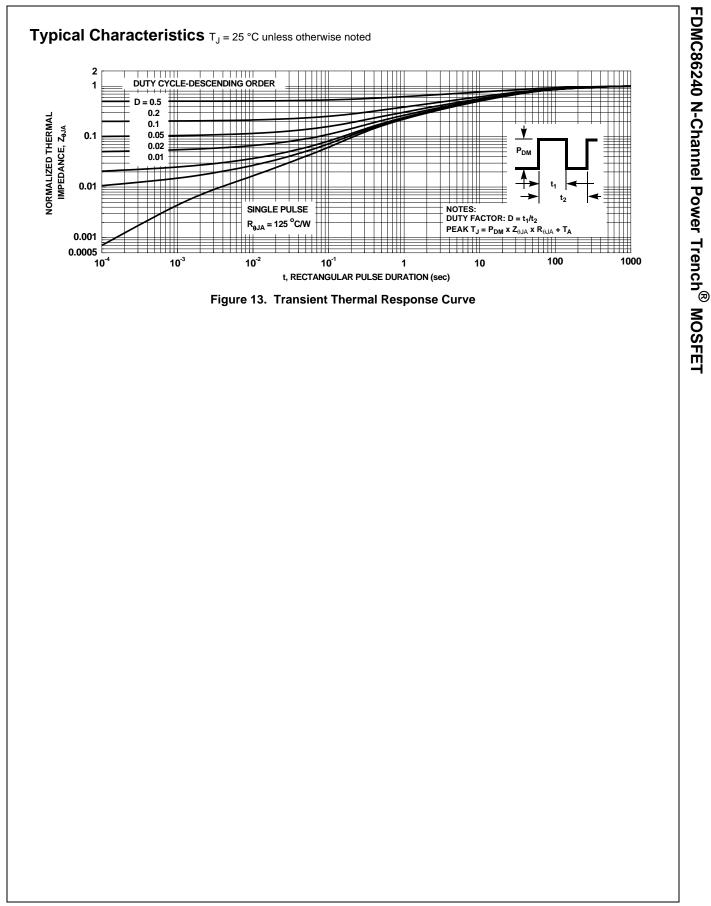
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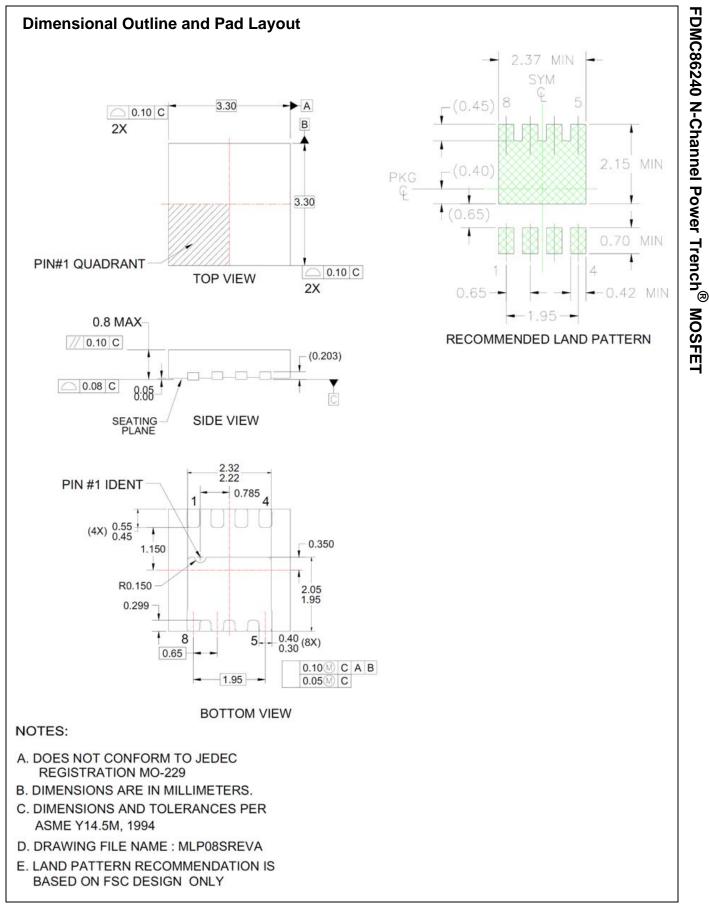
3. Starting T_J = 25 °C; N-ch: L = 3 mH, I_{AS} = 4.8 A, V_{DD} = 150 V, V_{GS} = 10 V.

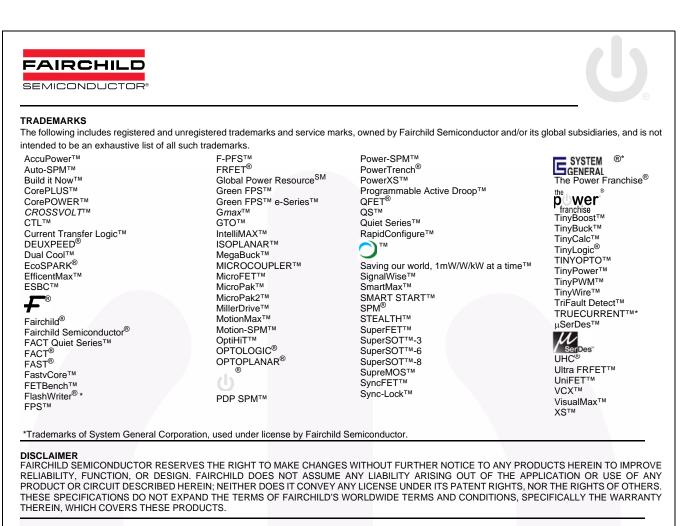
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